4-Ball Wafer Level Chip Scale Package [WLCSP]  
(CB-4-5)  
Dimensions shown in millimeters

- Top View (Ball Side Down)
  - Ball A1 Identifier
  - Ball Dimensions: 0.800, 0.760, 0.720

- Bottom View (Ball Side Up)
  - Ball Dimensions: 0.40, 0.560, 0.500, 0.440

- End View
  - Seating Plane Dimensions: 0.300, 0.260, 0.220
  - Co-planarity: 0.03